



# Product Change Notification

## 112489 - 00

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**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

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# Product Change Notification

**Change Notification #:** 112489 - 00  
**Change Title:** Intel® Server System R2308GL4GS, R2208GZ4GS9, R2216GZ4GC and R2312GZ4GS9  
PCN 112489-00, Product Design Update Rear Panel, Add Ground Studs  
**Date of Publication:** August 12, 2013

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>* Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Aug 27, 2013
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*\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

## Description of Change to the Customer:

Intel has implemented the following changes on Intel® Server System R2308GL4GS:

1. Add a small cut-out to the system rear panel to provide better clearance for latches on network cables plugging into the Dual Port Intel® X540 10GbE I/O Module AXX10GBTWLIOM.
2. Adding two ground studs on the system rear panel for future use. See Figure 1 below:



Figure 1: The ground studs

Intel has implemented the following change on Intel® Server System R2208GZ4GS9, R2216GZ4GC and R2312GZ4GS9:

1. Adding two ground studs on the system rear panel for future use (see Figure 1 above).

**Customer Impact of Change and Recommended Action:**

Intel recommends that the customer perform a standard level of evaluation as updated product become available.

**Products Affected / Intel Ordering Codes:**

EMEA SKUs			
Product Code	MM#	Pre Change TA	Post Change TA
R2216GZ4GC	917002	G52144-002	G52144-003
R2308GL4GS	917011	G52727-002	G52727-003
R2208GZ4GS9	922762	G67939-002	G67939-003
R2312GZ4GS9	922784	G67884-003	G67884-004

**PCN Revision History:**

**Date of Revision:**  
August 12, 2013

**Revision Number:**  
00

**Reason:**  
Originally Published PCN